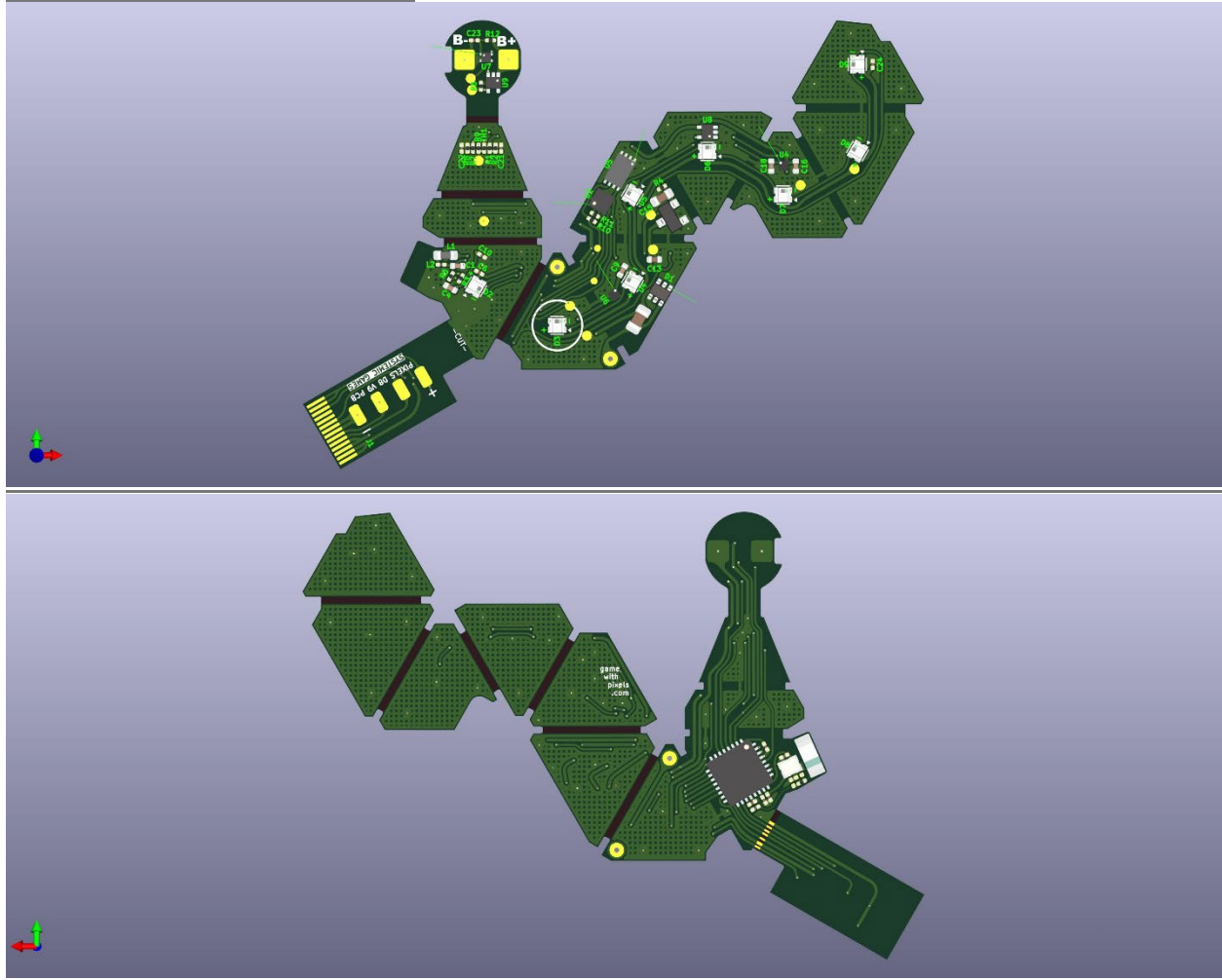# D8V9 FPC Specifications

PCB Type : Flexible PCB
Board type : Single pieces
Layer : 2 Layers
Material : Polyimide Flex:
FPC Thickness : 0.13 mm
Solder Mask (Coverlay) : Black Coverlay
Silkscreen : White / Black

Stiffener : BOT FR4 : 0.15 mm
        filename: *Main-B_Stiffener.gbr*

Surface Finish : Immersion gold (ENIG) (1U")
Finished Copper : 0.5 oz **Annealed** Cu (18μm)
E-test : 100%

3M/Tesa tape : BOT
      Glue: *Main-B_3M_Adhesive.gbr*
      Backing Tape: *Main-B_3M_Backing.gbr*

SMT: TOP + BOT